| ASSOCIATION CONNECTING<br>ELECTRONICS INDUSTRIES® International and Par | PC. Bannockl    | burn, Illinois, A          | Il rights reserved untions. | under both              | This docume<br>level parts, t   | ent is a declaration entities the declaration entities and the declaration entities and the declaration entities and the declaration entities are an entities are an entities and the declaration entities are an entits are an entities are an entits are an entities are an entities | on of the su                                  | bstances v<br>all lower | vithin the manufactu<br>level materials for v | urer listed which the   | item. Note:<br>manufactur       | : if the item is an as<br>er has engineering | sembly with low responsibility. |  |
|---|-----------------|----------------------------|-----------------------------|-------------------------|---|---|---|-------------------------|---|-------------------------|---------------------------------|--|---------------------------------|--|
| IPC Web Site for Information on IPC-1752 Standard For                   |                 |                            |                             | Form Type<br>Distribute | 2 * Declaration Class *<br>Class 6 - RoHS Yes/No, Homogeneous Materials and |   |   |                         |   | rials and N             | and Mfg Information             |  |                                 |  |
| Supplier Information  |                 |                            |                             |                         |   |   |   |                         |   |                         |                                 |  |                                 |  |
| Company name* Cor   |                 |                            | Company unique ID           |                         |   | Unique ID Authority   |   |                         |   | Respor                  | Response Date*                  |  |                                 |  |
| onsemi  |                 |                            |                             |                         |   |   |   |                         |   | 2025-0                  | 2025-06-06                      |  |                                 |  |
| ontact Name Title - Contact   |                 |                            | ct                          | Ţ                       |   |   | Phone - Contact*                              |                         |   |                         | Email - Contact*                |  |                                 |  |
| Product-Env-Stewards Product Env  |                 |                            | Enviro Compliance           |                         |   | NA  |   |                         |   | Produ                   | Product-Env-Stewards@onsemi.com |  |                                 |  |
| Authorized Representative* Title - Rep                                  |                 |                            | Representative              |                         |   | Phone - Representative*   |   |                         | Email   | Email - Representative* |                                 |  |                                 |  |
| Product-Env-Stewards Pro  |                 |                            | Product Enviro Compliance   |                         |   | NA  |   |                         |   | Produ                   | Product-Env-Stewards@onsemi.com |  |                                 |  |
| Requester Item Number   | Mfr Item Number |                            | umber Mfr Item Name         |                         |   | Effective Date  | Version                                       | М                       | Manufacturing Site                            |                         | Weight*                         | UOM  | Unit Type                       |  |
|   | SMMBT           | SMMBTA56LT3G SS SOT23 DR X |                             | TR SPCL TR              |   | 2025-06-06  |   | C                       | CN1   |                         | 8.02                            | mg   | Each                            |  |
| Ianufacturing Proccess Informa  | tion            |                            |                             |                         |   |   |   |                         |   |                         |                                 |  |                                 |  |
| Terminal Plating / Grid Array M   | aterial 7       | rial Terminal Base Alloy   |                             | J-STD-020 MSL           | -020 MSL Rating Pe  |   | Peak Process Body Temperature Max Time at Pea |                         | k Tempera                                     | ture Nun                | nber of Reflow Cyc              | les  |                                 |  |
| Matte Tin (Sn) - annealed CU Alloy                                      |                 | CU Alloy                   |                             | 1                       |   | 260   |   | С                       | 30  | seco                    | nds 3                           |  |                                 |  |
| omments   |                 |                            |                             |                         |   |   |   |                         |   |                         |                                 |  |                                 |  |
| vel 1 - maximum time at peak temperatu                                  | ire during so   | ldering is 10-3            | 0 seconds                   |                         |   |   |   |                         |   |                         |                                 |  |                                 |  |
| or more information regarding material                                  | composition     | please refer to            | page 3                      |                         |   |   |   |                         |   |                         |                                 |  |                                 |  |

| RoHS Material Composition Declaration  |  |  |   | Declaration Type *                              | Detailed  |  |  |  |  |  |  |  |
|--|--|--|---|---|---|--|--|--|--|--|--|--|
| Directive 2015/863/EU amending RoHS<br>Directive 2011/65/EU  | RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP). |  |   |   |   |  |  |  |  |  |  |  |
| cadmium, hexavalentchromium, polybrominate<br>contains a RoHS restricted substance inexcess<br>encompass all such components. Supplier certif<br>as of the date that Supplier completes this form<br>Company acknowledges that Supplier may hav<br>independently verified information provided by<br>certification in this paragraph. If the Company a | ed biphenyls and/or polybrominated dip<br>of an applicable quantity limit, please ir<br>ies that it gathered the information it pro-<br>.Supplier acknowledges that Company<br>e relied on informationprovided by othe<br>v others, Supplier agrees that, at a minin<br>and the Supplier enter into a written agre<br>pource of the Supplier's liability and the   | henyl ethers (each a "<br>ndicate below which, i<br>ovides in this form us<br>will rely on this certifiers<br>in completing this<br>num, itssuppliers have<br>eement with respect to<br>Company's remedies | RoHS restricted substance") in exce<br>if any, RoHS exemption you believe<br>ing appropriate methods to ensure if<br>ication in determining the complian<br>form, and that Supplier may not have<br>e provided certifications regarding the<br>to the identified part, the terms and co<br>for issues that arise regarding inform | ce of its products with European Union membe    | ove. If a homogeneous material within the part<br>er level components, the declaration shall<br>l correct to the best of its knowledge and belief,<br>r state laws that implement the RoHS Directive.<br>wever, in situations where Supplier has not<br>tions are at least as comprehensive as the<br>anty rights and/or remedies provided as part of |  |  |  |  |  |  |  |
| RoHS Declaration * 1 - Item(s)   | does not contain RoHS restricted substa  | ances per the definitio  | on above  | Supplier Acceptance                             | * Accepted  |  |  |  |  |  |  |  |
| Exemption: If the declared item does not con applicable exemptions.  | ntain RoHS restricted substances per   | the definition above   | except for defined RoHS exempti   | ons, then select the corresponding response i   | n the RoHS Declaration above and choose all   |  |  |  |  |  |  |  |
| Exemption List Version   | EL-2011/534/EU   |  |   |   |   |  |  |  |  |  |  |  |
| Declaration Signature  |  |  |   |   |   |  |  |  |  |  |  |  |
| Instructions: Complete all of the required fin<br>Requester) and click on Submit Form to have  | elds on all pages of this form. Select the form returned to the Requester  | he "Accepted" on th  | e Supplier Acceptance drop-down   | . This will display the signature area. Digital | lly sign the declaration (if required by the  |  |  |  |  |  |  |  |
| Supplier Digital Signature Ra  | stislav Drska  | Le   |   |   |   |  |  |  |  |  |  |  |

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

| sigma range of distribution unless | otherwise noted). |                 |          |  |             |        |        |                 |
|------------------------------------|-------------------|-----------------|----------|--|-------------|--------|--------|-----------------|
| Homogeneous Material               | Weight            | Unit of Measure | Level    | Substance  | CAS         | Exempt | Weight | Unit of Measure |
| Die                                | 0.05              | mg              | Supplier | Silicon (Si)   | 7440-21-3   |        | 0.05   | mg              |
| Lead Frame                         | 2.92              | mg              | В        | Nickel (Ni)  | 7440-02-0   |        | 1.06   | mg              |
|                                    |                   |                 | Supplier | Iron (Fe)  | 7439-89-6   |        | 1.4658 | mg              |
|                                    |                   |                 | Supplier | Copper (Cu)  | 7440-50-8   |        | 0.3942 | mg              |
| Mold Compound-Black                | 4.9               | mg              | Supplier | Boron zinc hydroxide oxide                             | 138265-88-0 |        | 0.147  | mg              |
|                                    |                   |                 | Supplier | Zinc Monoxide (ZnO)                                    | 1314-13-2   |        | 0.0245 | mg              |
|                                    |                   |                 | Supplier | 2,4,6-triamino-s-triazincompd.withs-<br>triazine-triol | 37640-57-6  |        | 0.147  | mg              |
|                                    |                   |                 | Supplier | Silica Amorphous (SiO2)                                | 7631-86-9   |        | 3.92   | mg              |
|                                    |                   |                 | Supplier | Carbon Black (C)                                       | 1333-86-4   |        | 0.049  | mg              |
|                                    |                   |                 | Supplier | Ortho-Cresol Novolac Resin                             | 29690-82-2  |        | 0.392  | mg              |
|                                    |                   |                 | Supplier | Phenolic Resin (Novolac)                               | 9003-35-4   |        | 0.2205 | mg              |
| Plating                            | 0.14              | mg              | Supplier | Tin (Sn)   | 7440-31-5   |        | 0.14   | mg              |
| Wire Bond                          | 0.01              | mg              | Supplier | Palladium (Pd)   | 7440-05-3   |        | 0.0001 | mg              |
|                                    |                   |                 | Supplier | Copper (Cu)  | 7440-50-8   |        | 0.0099 | mg              |

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 signa range of distribution unless otherwise noted).